74LVC240A

Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

Rev. 8 — 29 November 2011

Product data sheet

1. General description

The 74LVC240A is an octal inverting buffer/line driver with 3-state outputs. The 3-state outputs are controlled by the output enable inputs 1OE and 2OE. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state. Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V or 5 V applications.

The 74LVC240A is functionally identical to the 74LVC244A except that the 244 has non-inverting outputs.

2. Features and benefits

- 5 V tolerant inputs for interlacing with 5 V logic
- Supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



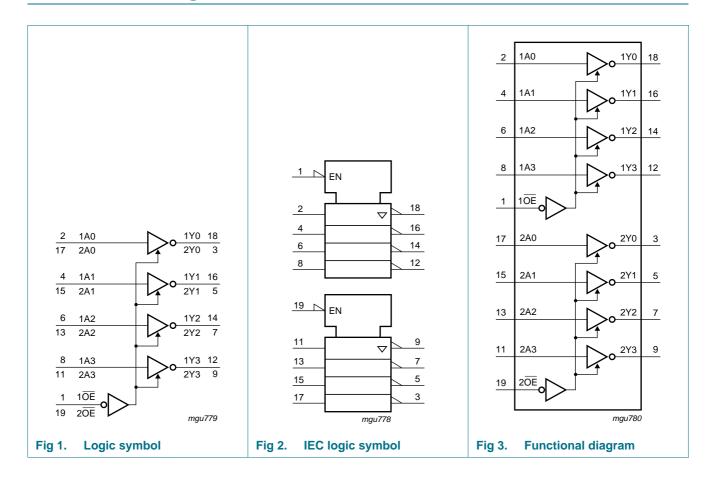
Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

3. Ordering information

Table 1. Ordering information

Type number	Package	Package										
	Temperature range	Name	Description	Version								
74LVC240AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1								
74LVC240ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1								
74LVC240APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1								
74LVC240ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 \times 4.5 \times 0.85 mm	SOT764-1								

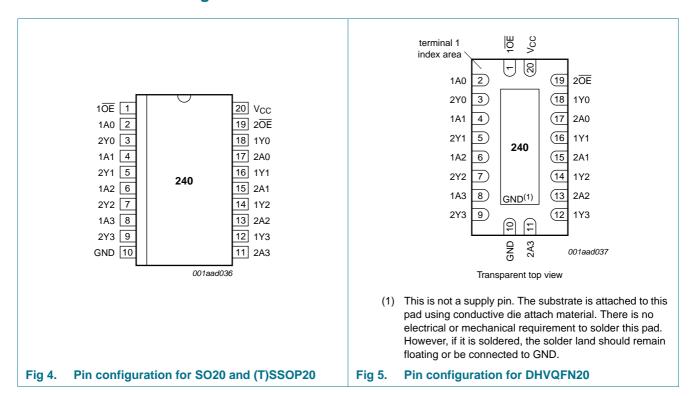
4. Functional diagram



Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1 OE	1	output enable input (active LOW)
2 OE	19	output enable input (active LOW)
1A[0:3]	2, 4, 6, 8	data input
2A[0:3]	17, 15, 13, 11	data input
1Y[0:3]	18, 16, 14, 12	data output
2Y[0:3]	3, 5, 7, 9	data output
GND	10	ground (0 V)
V_{CC}	20	power supply

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6. Functional description

Table 3. Function selection[1]

Inputs nOE		Output
nOE	nAn	nYn
L	L	Н
L	Н	L
Н	X	Z

^[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

Z = high-impedance OFF-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0	-50	-	mA
V _I	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0$	-	±50	mA
V _O	output voltage	output HIGH or LOW state	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[2]</u> –0.5	+6.5	V
I _O	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	<u>[3]</u> _	500	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

For (T)SSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.

For DHVQFN20 packages: above 60 °C derate linearly with 4.5 mW/K.

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SO20 packages: above 70 °C derate linearly with 8 mW/K.

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8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V_{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall	V _{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
	rate	V _{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V_{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
/ _{OH} HIGH-level		$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.2	-	-	V _{CC} – 0.3	-	V
		$I_O = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V_{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}$; $V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	8.0	V
l _l	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ

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Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	°C	–40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 3.6$ V; $V_O = 5.5$ V or GND;	-	±0.1	±10	-	±20	μΑ
l _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	-	0.1	±10	-	±20	μА
I _{CC}	supply current	V_{CC} = 3.6 V; V_{I} = V_{CC} or GND; I_{O} = 0 A	-	0.1	10	-	40	μА
ΔI_{CC}	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}$	-	5	500	-	5000	μА
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t_{pd}	propagation	1An to 1Yn; 2An to 2Yn; see Figure 6	[2]						
	delay	V _{CC} = 1.2 V		-	16	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.0	5.7	12.7	1.0	14.6	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	3.0	6.6	0.5	7.6	ns
		V _{CC} = 2.7 V		1.5	3.1	7.0	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.3	2.6	5.5	1.3	7.0	ns
t _{en}	enable time	1OE to 1Yn; 2OE to 2Yn; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	19	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.5	6.3	15.9	1.5	18.3	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	3.6	8.8	1.5	10.1	ns
		V _{CC} = 2.7 V		1.0	3.7	8.5	1.0	11.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.1	2.9	7.0	1.1	9.0	ns
t _{dis}	disable time	1OE to 1Yn; 2OE to 2Yn; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	17	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		2.3	4.1	9.9	2.3	11.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.4	5.6	1.0	6.5	ns
		V _{CC} = 2.7 V		1.5	3.1	7.5	1.5	9.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.4	2.9	6.0	1.4	7.5	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns

Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
C_{PD}	power	per buffer; $V_I = GND$ to V_{CC}	<u>[4]</u>			•	•	•	
dissipation capacitance	•	V _{CC} = 1.65 V to 1.95 V		-	2.0	-		-	pF
	capacitarice	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	5.2	-		-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	8.1	-		-	pF

- [1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.
- $\begin{array}{ll} [2] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}. \\ & t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}. \\ & t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}. \end{array}$
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o) \text{ where:}$

f_i = input frequency in MHz; f_o = output frequency in MHz

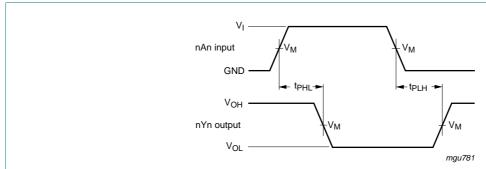
C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs

11. AC waveforms



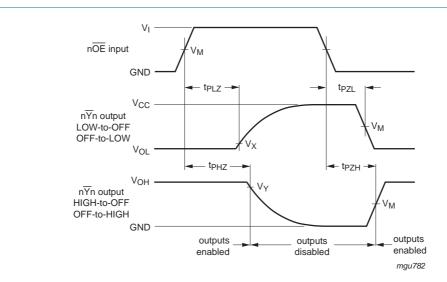
 $V_{M} = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V};$

 $V_M = 0.5 \times V_{CC}$ at $V_{CC} < 2.7 V$;

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 6. Inputs (1An, 2An) to outputs (1Yn, 2Yn) propagation delays

Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state



 $V_M = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V}.$

 $V_M = 0.5 \times V_{CC}$ at $V_{CC} < 2.7$ V.

 V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

 $V_X = V_{OL} + 0.3 \text{ V at } V_{CC} \ge 2.7 \text{ V};$

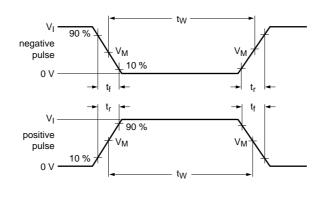
 $V_X = V_{OL} + 0.15 \text{ V at } V_{CC} < 2.7 \text{ V};$

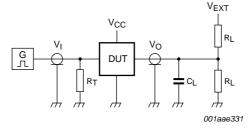
 V_Y =V_{OH} - 0.3 V at $V_{CC} \geq$ 2.7 V;

 V_Y =V $_{OH}$ - 0.15 V at V_{CC} < 2.7 V.

Fig 7. 3-state enable and disable times

Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state





Test data is given in Table 8.

Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 8. Test circuit for measuring switching times

Table 8. Test data

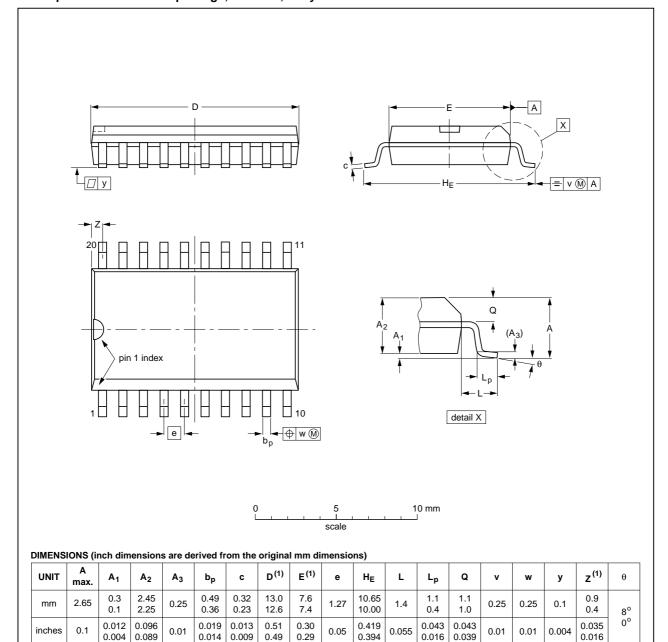
Supply voltage	Input		Load		V _{EXT}	V _{EXT}				
	VI	t _r , t _f	CL	R_L	t _{PLH} , t _{PHL}	t_{PLZ}, t_{PZL}	t _{PHZ} , t _{PZH}			
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 k Ω	open	$2\times V_{CC}$	GND			
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND			
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND			
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND			
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND			

Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting;

12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	155UE DATE	
SOT163-1	075E04	MS-013				99-12-27 03-02-19	

Fig 9. Package outline SOT163-1 (SO20)

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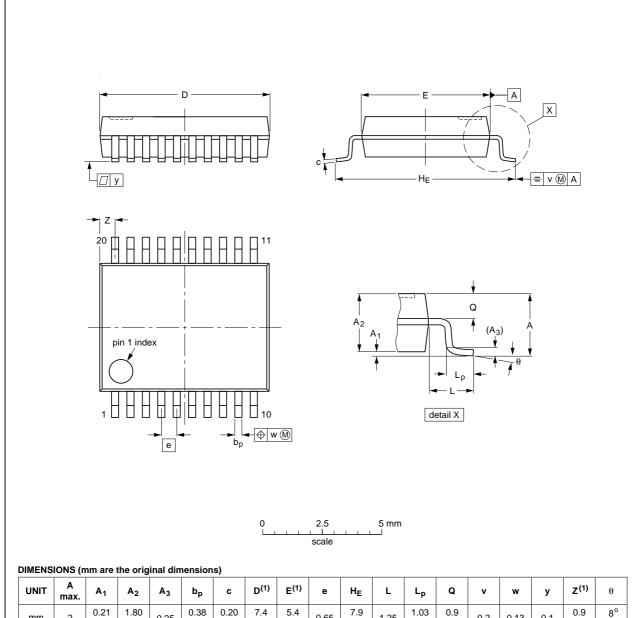
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74LVC240A **NXP Semiconductors**

Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	ø	v	w	у	Z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

	OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
	VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	SOT339-1		MO-150				99-12-27 03-02-19

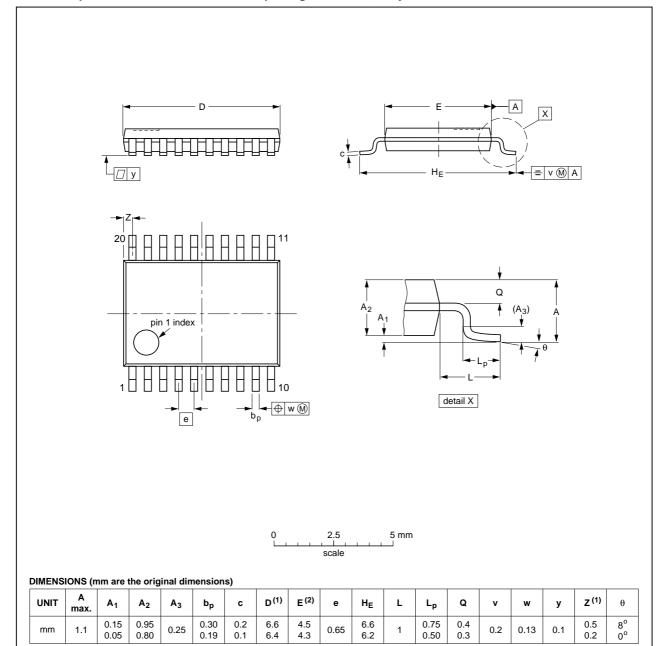
Fig 10. Package outline SOT339-1 (SSOP20)

74LVC240A

Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT360-1		MO-153				99-12-27 03-02-19

Fig 11. Package outline SOT360-1 (TSSOP20)

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Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

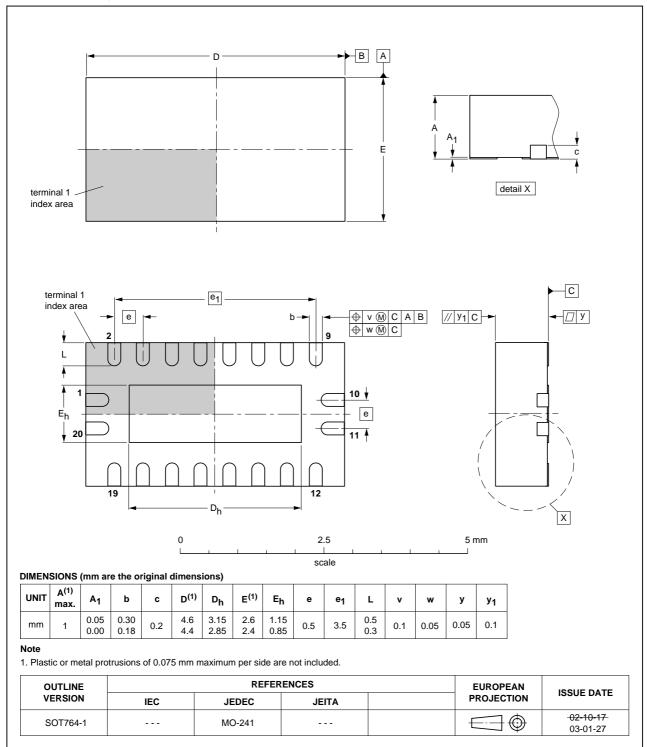


Fig 12. Package outline SOT764-1 (DHVQFN20)

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Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

13. Abbreviations

Table 9. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 10. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC240 v.8	20111129	Product data sheet	-	74LVC240A v.7
Modifications:	• <u>Table 7</u> : maxim	num values for lower voltage ranç	ges changed (errata).	
74LVC240A v.7	20111027	Product data sheet	-	74LVC240A v.6
Modifications:		his data sheet has been redesign IXP Semiconductors.	ned to comply with the	new identity
	 Legal texts have 	e been adapted to the new com	pany name where app	ropriate.
	• Table 4, Table	5, <u>Table 6, Table 7</u> and <u>Table 8</u> : v	values added for lower	voltage ranges.
74LVC240A v.6	20031202	Product specification	-	74LVC240A v.5
74LVC240A v.5	20030514	Product specification	-	74LVC240A v.4
74LVC240A v.4	20021220	Product specification	-	74LVC240A v.3
74LVC240A v.3	20021002	Product specification	-	74LVC240A v.2
74LVC240A v.2	19980520	Product specification	-	74LVC240A v.1
74LVC240A v.1	-	Product specification	-	-

Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting;

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

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